# Surface Mount Zener Diode





#### Features:

- Planar Die Construction
- 350mW Power Dissipation
- · General Purpose, Medium Current
- Ideally Suited for Automated Assembly Processes

## **Application:**

350mW Surface mount zener diode

## Maximum Rating @ T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Forward voltage @ I <sub>F</sub> = 10mA	V <sub>F</sub>	0.9	V
Power dissipation	P <sub>D</sub>	350	mW
Thermal resistance, junction to ambient air	R <sub>θjA</sub>	357	°C/W
Operating and storage temperature range	T <sub>j,</sub> T <sub>stg</sub>	-65 to +150	°C

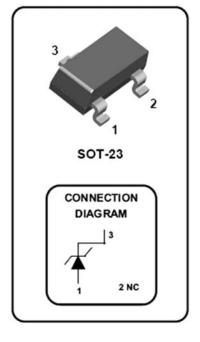
**Note :** Valid provided that device terminals are kept at ambient temperature. Tested with pulses,  $T_p \le 1$ ms.

## Electrical Characteristics @ T<sub>A</sub> = 25°C unless otherwise specified

		Zener Voltage Range			Maximum Zener Impedance		Maximum Reverse Leakage Current		
Type Number	Marking Code	V <sub>z</sub> @I <sub>ZT</sub>			I <sub>zt</sub>	Z <sub>ZT</sub> @I <sub>ZT</sub>	Z <sub>ZK</sub> @I <sub>ZK</sub> = 0.25mA	I <sub>R</sub>	@V <sub>R</sub>
		Nom(V)	Min(V)	Max(V)	(mA)		(Ω)	(μΑ)	(V)
MMBZ5245B	KH5	15	14.25	15.75	8.5	16	600	0.1	11

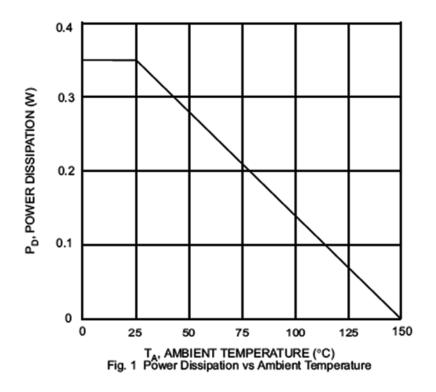
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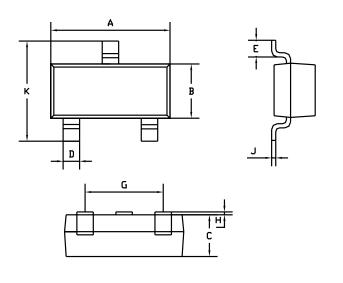


# Typical Characteristics @ TA = 25°C unless otherwise specified



## Package Outline

Plastic surface mounted package



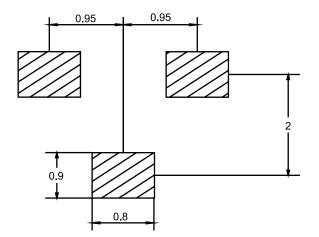
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SOT-23				
Dim	Min	Max		
А	2.85	2.95		
В	1.25	1.35		
С	1 Typical			
D	0.37	0.43		
E	0.35	0.48		
G	1.85	1.95		
Н	0.02	0.1		
J	0.1 Typical			
К	2.35	2.45		
All Dimensions in mm				





# **Soldering Footprint**



## **Package Information**

Device	Package	Shipping
MMBZ5245B-7-F	SOT-23	3,000/Tape & Reel

**Dimensions : Millimetres** 

## Part Number Table

Description	Part Number	
350mW Surface Mount Zener Diode	MMBZ5245B-7-F	

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